

AMENDMENTS TO THE CLAIMS

Claims 1-16 (canceled)

17. (original) A charge pump circuit comprising:

four phase circuits, each of said phase circuits including a primary phase circuit and a respective ancillary phase circuit, said respective ancillary phase circuits each serving to control a transistor of said respective primary phase circuit, said four primary phase circuits operated out of phase with one another.

18. (currently amended) The ~~[[A]]~~ charge pump circuit ~~as defined in~~ of claim 17, wherein said respective ancillary phase circuits each operate out of phase with one another.

Claims 19-23 (canceled)

24. (new) A charge pump, comprising:

a plurality of single phase charge pump circuits, each comprising a bootstrap capacitor;
a plurality of ancillary charge pump circuits, each respectively associated with one of said plurality of single phase charge pump circuits, and each comprising a ancillary

capacitor coupled to the bootstrap capacitor of the associated single phase charge pump circuit; and

a plurality of charge transfer circuits for transferring charge between said plurality of single phase charge pump circuits.

25. (new) The charge pump of claim 24, wherein at least two of said plurality of single phase charge pump circuits are operated in offset phase from another.

26. (new) The charge pump of claim 24, wherein at least two of said plurality of ancillary charge pump circuits are operated in offset phase from another.

27. (new) The charge pump of claim 24, wherein there are four single phase charge pump circuits each operated at an offset phase with respect the others of said plurality of charge pumps.

28. (new) The charge pump of claim 26, wherein said plurality of single phase charge pump circuits comprise:

a first single phase charge pump circuit operating at an initial phase;

a second single phase charge pump circuit operating at a phase angle of 90° relative to said initial phase;

a third single phase charge pump circuit operating at a phase angle of 180° relative to said initial phase; and

a fourth single phase charge pump circuit operating at a phase angle of 270° relative to said initial phase.

29. (new) An integrated circuit, comprising:

a semiconductor substrate;

a charge pump, disposed on said substrate, said charge pump comprising:

a plurality of single phase charge pump circuits, each comprising a bootstrap capacitor and a single phase charge pump output;

a plurality of ancillary charge pump circuits, each respectively associated with one of said plurality of single phase charge pump circuits, and each comprising an ancillary capacitor coupled to the bootstrap capacitor of the associated single phase charge pump circuit;

a plurality of charge transfer circuits for transferring charge between said plurality of single phase charge pump circuits; and

a charge pump output, coupled to each of said single phase charge pump outputs; and

a first circuit, disposed on said substrate, and coupled to said charge pump output.

30. (new) The integrated circuit of claim 29, wherein at least two of said plurality of single phase charge pump circuits are operated in offset phase from another.

31. (new) The integrated circuit of claim 29, wherein at least two of said plurality of ancillary charge pump circuits are operated in offset phase from another.

32. (new) The integrated circuit p of claim 29, wherein there are four single phase charge pump circuits each operated at an offset phase with respect the others of said plurality of charge pumps.

33. (new) The integrated circuit of claim 32, wherein plurality of single phase charge pump circuits comprise:

a first single phase charge pump circuit operating at an initial phase;

a second single phase charge pump circuit operating at a phase angle of 90° relative to said initial phase;

a third single phase charge pump circuit operating at a phase angle of 180° relative to said initial phase; and

a fourth single phase charge pump circuit operating at a phase angle of 270° relative to said initial phase.

34. (new) An memory device, comprising:

a semiconductor substrate;

a charge pump, disposed on said substrate, said charge pump comprising:

a plurality of single phase charge pump circuits, each comprising a bootstrap capacitor and a single phase charge pump output;

a plurality of ancillary charge pump circuits, each respectively associated with one of said plurality of single phase charge pump circuits, and each comprising an ancillary capacitor coupled to the bootstrap capacitor of the associated single phase charge pump circuit;

a plurality of charge transfer circuits for transferring charge between said plurality of single phase charge pump circuits; and

a charge pump output, coupled to each of said single phase charge pump outputs; and

a memory circuit, disposed on said substrate, and coupled to said charge pump output.

35. (new) The memory device of claim 29, wherein at least two of said plurality of single phase charge pump circuits are operated in offset phase from another.

36. (new) The memory device of claim 29, wherein at least two of said plurality of ancillary charge pump circuits are operated in offset phase from another.

37. (new) The memory device of claim 29, wherein there are four single phase charge pump circuits each operated at an offset phase with respect the others of said plurality of charge pumps.

38. (new) The memory device of claim 32, wherein said plurality of single phase charge pump circuits comprise:

a first single phase charge pump circuit operating at an initial phase;

a second single phase charge pump circuit operating at a phase angle of 90° relative to said initial phase;

a third single phase charge pump circuit operating at a phase angle of 180° relative to said initial phase; and

a fourth single phase charge pump circuit operating at a phase angle of 270° relative to said initial phase.

39. (new) An integrated circuit comprising:

charge pump circuit including,

a first charge pump phase circuit including a first bootstrap capacitor containing stored energy;

a second charge pump phase circuit including a second bootstrap capacitor; and

a circuit including a flip-flop for transferring energy from said first bootstrap capacitor to said second bootstrap capacitor to enable said second bootstrap capacitor to utilize energy previously stored in said first bootstrap capacitor to elevate a potential on said second bootstrap capacitor, said transferring occurring in response to a control signal generated by toggling said flip-flop.

40. (new) A memory device comprising:

a charge pump circuit including four phase circuits, each of said phase circuits including a primary phase circuit and a respective ancillary phase circuit, said respective ancillary phase circuits each serving to control a transistor of said respective primary phase circuit, said four primary phase circuits operated out of phase with one another.

41. (new) The memory device according to claim 40, wherein said respective ancillary phase circuits each operate out of phase with one another.

42. (new) A memory device comprising:

a memory circuit; and

a charge pump circuit, coupled to said memory circuit, said multi-phase charge pump circuit comprising:

a plurality of single phase charge pump circuits each including a respective bootstrap capacitor, at least four single phase charge pump circuits of said plurality of signal phase charge pump circuits operated in offset phase from one another; and

a charge transfer circuit adapted to transfer charge between said at least two single phase charge pump circuits of said plurality of single phase charge pump circuits operated in offset phase from one another, wherein said plurality of single phase charge pump circuits includes at least a first single phase charge pump circuit, a second single phase charge pump circuit, a third single phase charge pump circuit, and a fourth single phase charge pump circuit, each operating at respective phase angles of 0° , 90° , 180° , and 270° .

43. (new) A memory device comprising:

a memory circuit; and

a charge pump circuit, coupled to said memory circuit, said charge pump circuit comprising:

a first charge pump phase circuit including a first bootstrap capacitor containing stored energy;

a second charge pump phase circuit including a second bootstrap capacitor; and

a circuit including a flip-flop for transferring energy from said first bootstrap capacitor to said second bootstrap capacitor to enable said second bootstrap capacitor to utilize energy previously stored in said first bootstrap capacitor to

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elevate a potential on said second bootstrap capacitor, said transferring occurring in response to a control signal generated by toggling said flip-flop.